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ON Semiconductor®

May 2017

FOD8343, FOD8343T

4.0 A Output Current, High Speed Gate Drive Optocoupler in Stretched Body SOP 6-Pin

Features

- FOD8343T - 8 mm Creepage and Clearance Distance, and 0.4 mm Insulation Distance to Achieve Reliable and High-Voltage Insulation
- 4.0 A Maximum Peak Output Current Driving Capability for Medium- Power IGBT/MOSFET
 - Use of P-Channel MOSFETs at Output Stage Enables Output Voltage Swing Close to Supply Rail
- 50 kV/ μ s Minimum Common Mode Rejection Wide Supply Voltage Range: 10 V to 30 V
- Fast Switching Speed Over Full Operating Temperature Range
 - 210 ns Maximum Propagation Delay
 - 65 ns Maximum Pulse Width Distortion Under-Voltage Lockout (UVLO) with Hysteresis
- Extended Industrial Temperature Range: -40°C to 100°C
- Safety and Regulatory Approvals:
 - UL1577, 5,000 V_{RMS} for 1 Minute
 - DIN EN/IEC60747-5-5, 1,140V Peak Working Insulation Voltage (Pending Approvals)

Application

- AC and Brushless DC Motor Drives
- Industrial Inverter
- Uninterruptible Power Supply Induction Heating
- Isolated IGBT/Power MOSFET Gate Drive

Related Resources

- [FOD3182, 3 A Output Current, High Speed MOSFET Gate Drive Optocoupler](#)
- [FOD8314, FOD8314T, 1.0 A Output Current, Gate Drive Optocoupler in Stretched Body SOP 6-Pin](#)

Description

The FOD8343 series is a 4.0 A maximum peak output current gate drive optocoupler, capable of driving medium-power IGBT/ MOSFETs. It is ideally suited for fast-switching driving of power IGBT and MOSFET used in motor-control inverter applications, and high-performance power systems.

The FOD8343 series utilizes stretched body package to achieve 8 mm creepage and clearance distances (FOD8343T), and optimized IC design to achieve reliably high-insulation voltage and high-noise immunity.

The FOD8343 series consists of an Aluminum Gallium Arsenide (AlGaAs) Light-Emitting Diode (LED) optically coupled to an integrated circuit with a high-speed driver for push-pull MOSFET output stage. The device is housed in a stretched body, 6-pin, small outline, plastic package.

Functional Schematic

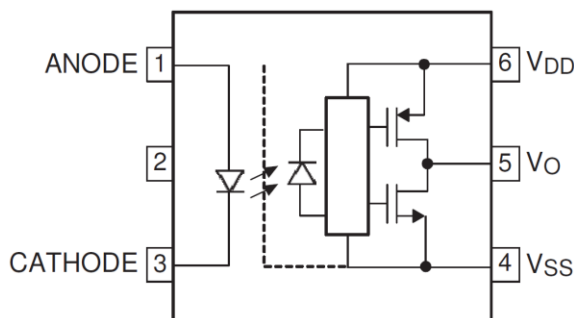


Figure 1. Schematic

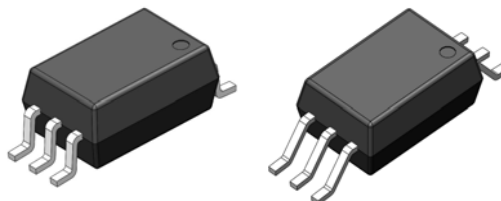


Figure 2. Package Outline

Truth Table

LED	$V_{DD} - V_{SS}$ “Positive Going” (Turn-on)	$V_{DD} - V_{SS}$ “Negative Going” (Turn-off)	V_O
Off	0 V to 30 V	0 V to 30 V	LOW
On	0 V to 7 V	0 V to 6.5 V	LOW
On	7 V to 9.5 V	6.5 V to 9 V	Transition
On	9.5 V to 30 V	9 V to 30 V	HIGH

Pin Definitions

Pin #	Name	Description
1	ANODE	LED Anode
2	N.C	Not Connection
3	CATHODE	LED Cathode
4	V_{SS}	Negative Supply Voltage
5	V_O	Output Voltage
6	V_{DD}	Positive Supply Voltage

Pin Configuration

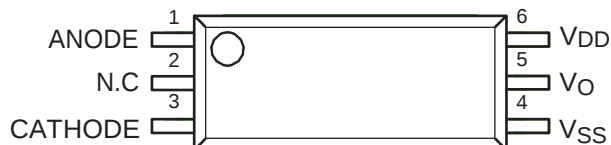


Figure 3. Pin Configuration

Safety and Insulation Ratings

As per DIN EN/IEC60747-5-5 (pending approvals), this optocoupler is suitable for “safe electrical insulation” only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter		Characteristics	
		FOD8343	FOD8343T
Installation Classifications per DIN VDE 0110/1.89 Table 1, For Rated Mains Voltage	< 150 V _{RMS}	I–IV	I–IV
	< 300 V _{RMS}	I–IV	I–IV
	< 450 V _{RMS}	I–III	I–IV
	< 600 V _{RMS}	I–III	I–III
Climatic Classification		40/100/21	40/100/21
Pollution Degree (DIN VDE 0110/1.89)		2	2
Comparative Tracking Index		175	175

Symbol	Parameter	Value		Unit
		FOD8343	FOD8343T	
V _{PR}	Input-to-Output Test Voltage, Method B, V _{IORM} × 1.875 = V _{PR} , 100% Production Test with t _m = 1 s, Partial Discharge < 5 pC	1,671	2,137	V _{peak}
	Input-to-Output Test Voltage, Method A, V _{IORM} × 1.6 = V _{PR} , Type and Sample Test with t _m = 10 s, Partial Discharge < 5 pC	1,426	1,824	V _{peak}
V _{IORM}	Maximum Working Insulation Voltage	891	1,140	V _{peak}
V _{IOTM}	Highest Allowable Over-Voltage	6,000	8,000	V _{peak}
	External Creepage	≥ 8.0	≥ 8.0	mm
	External Clearance	≥ 7.0	≥ 8.0	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥ 0.4	≥ 0.4	mm
T _S	Safety Limit Values – Maximum Values Allowed in the Event of a Failure, Case Temperature	150	150	°C
I _{S,INPUT}	Input Current	200	200	mA
P _{S,OUTPUT}	Output Power	600	600	mW
R _{IO}	Insulation Resistance at T _S , V _{IO} = 500 V	10 ⁹	10 ⁹	Ω

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise specified.)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Unit
T_{STG}	Storage Temperature	-40 to +125	$^\circ\text{C}$
T_{OPR}	Operating Temperature	-40 to +100	$^\circ\text{C}$
T_J	Junction Temperature	-40 to +125	$^\circ\text{C}$
T_{SOL}	Lead Solder Temperature (Refer to Reflow Temperature Profile)	260 for 10 sec	$^\circ\text{C}$
$I_{\text{F(AVG)}}$	Average Input Current	25	mA
V_R	Reverse Input Voltage	5.0	V
$I_{\text{O(PEAK)}}$	Peak Output Current ⁽¹⁾	4	A
V_{DD}	Supply Voltage	-0.5 to 35	V
$V_{\text{O(PEAK)}}$	Peak Output Voltage	0 to V_{DD}	V
$t_{\text{R(IN)}}$, $t_{\text{F(IN)}}$	Input Signal Rise and Fall Time	250	ns
PD_I	Input Power Dissipation ⁽²⁾⁽⁴⁾	45	mW
PD_O	Output Power Dissipation ⁽³⁾⁽⁴⁾	500	mW

Notes:

1. Maximum pulse width = 10 μs
2. No derating required across operating temperature range.
3. Derate linearly from 25°C at a rate of $5.2\text{ mW}/^\circ\text{C}$.
4. Functional operation under these conditions is not implied. Permanent damage may occur if the device is subjected to conditions outside these ratings.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
T_A	Ambient Operating Temperature	-40	+100	$^\circ\text{C}$
$V_{\text{DD}} - V_{\text{SS}}$	Supply Voltage	10	30	V
$I_{\text{F(ON)}}$	Input Current (ON)	10	16	mA
$V_{\text{F(OFF)}}$	Input Voltage (OFF)	-3.0	0.8	V

Isolation Characteristics

Apply over all recommended conditions, typical value is measured at $T_A = 25^\circ\text{C}$.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{ISO}	Input-Output Isolation Voltage	$T_A = 25^\circ\text{C}$, R.H. < 50%, $t = 1.0$ minute, $I_{I-O} \leq 20 \mu\text{A}^{(5)(6)}$	5000			VAC_{RMS}
R_{ISO}	Isolation Resistance	$V_{I-O} = 500 \text{ V}^{(5)}$		10^{11}		Ω
C_{ISO}	Isolation Capacitance	$V_{I-O} = 0 \text{ V}$, Frequency = 1.0 MHz ⁽⁵⁾		1		pF

Notes:

- Device is considered a two terminal device: pins 1, 2 and 3 are shorted together and pins 4, 5 and 6 are shorted together.
- 5,000 VAC_{RMS} for 1 minute duration is equivalent to 6,000 VAC_{RMS} for 1 second duration.

Electrical Characteristics

Apply over all recommended conditions, typical value is measured at $V_{DD} = 30 \text{ V}$, $V_{SS} = \text{Ground}$, $T_A = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Input Forward Voltage	$I_F = 10 \text{ mA}$	1.1	1.5	1.8	V
$\Delta(V_F/T_A)$	Temperature Coefficient of Forward Voltage			-1.8		mV/ $^\circ\text{C}$
BV_R	Input Reverse Breakdown Voltage	$I_R = 10 \mu\text{A}$	5.0			V
C_{IN}	Input Capacitance	$f = 1 \text{ MHz}$, $V_F = 0 \text{ V}$		20		pF
I_{OH}	High Level Output Current ⁽¹⁾	$V_{OH} = V_{DD} - 3 \text{ V}$	1.0			A
		$V_{OH} = V_{DD} - 10 \text{ V}$	3.0			A
I_{OL}	Low Level Output Current ⁽¹⁾	$V_{OL} = V_{SS} + 3 \text{ V}$	1.0			A
		$V_{OL} = V_{SS} + 10 \text{ V}$	3.0			A
V_{OH}	High Level Output Voltage ⁽⁷⁾⁽⁸⁾	$I_F = 10 \text{ mA}$, $I_O = -100 \text{ mA}$	$V_{DD} - 0.5$	$V_{DD} - 0.1$		V
V_{OL}	Low Level Output Voltage ⁽⁷⁾⁽⁸⁾	$I_F = 0 \text{ mA}$, $I_O = 100 \text{ mA}$		$V_{SS} + 0.1$	$V_{SS} + 0.5$	V
I_{DDH}	High Level Supply Current	$V_O = \text{Open}$, $I_F = 10$ to 16 mA		2.9	4.0	mA
I_{DDL}	Low Level Supply Current	$V_O = \text{Open}$, $V_F = -3.0$ to 0.8 V		2.8	4.0	mA
I_{FLH}	Threshold Input Current Low to High	$I_O = 0 \text{ mA}$, $V_O > 5 \text{ V}$		2.0	7.5	mA
V_{FHL}	Threshold Input Voltage High to Low	$I_O = 0 \text{ mA}$, $V_O < 5 \text{ V}$	0.8			V
V_{UVLO+}	UnderVoltage Lockout	$I_F = 10 \text{ mA}$, $V_O > 5 \text{ V}$	7.0	8.3	9.5	V
V_{UVLO-}	Threshold	$I_F = 10 \text{ mA}$, $V_O < 5 \text{ V}$	6.5	7.7	9.0	V
$UVLO_{HYS}$	UnderVoltage Lockout Threshold Hysteresis			0.6		V

Notes:

- In this test, V_{OH} is measured with a dc load current of 100 mA. When driving capacitive load V_{OH} will approach V_{DD} as I_{OH} approaches 0 A.
- Maximum pulse width = 1 ms, maximum duty cycle = 20%.

Switching Characteristics

Apply over all recommended conditions, typical value is measured at $V_{DD} = 30V$, $V_{SS} = \text{Ground}$, $T_A = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t_{PHL}	Propagation Delay Time to Logic Low Output ⁽⁹⁾	$I_F = 10 \text{ mA}$, $R_g = 10 \Omega$, $C_g = 10 \text{ nF}$, $f = 250 \text{ kHz}$, Duty Cycle = 50%	50	145	210	ns
t_{PLH}	Propagation Delay Time to Logic High Output ⁽¹⁰⁾		50	120	210	ns
PWD	Pulse Width Distortion ⁽¹¹⁾ $ t_{PHL} - t_{PLH} $			35	65	ns
PDD (Skew)	Propagation Delay Difference Between Any Two Parts ⁽¹²⁾		-90		90	
t_R	Output Rise Time (10% to 90%)			38		ns
t_F	Output Fall Time (90% to 10%)			24		ns
$t_{ULVO \text{ ON}}$	ULVO Turn On Delay	$I_F = 10 \text{ mA}$, $V_O > 5 \text{ V}$		2.0		μs
$t_{ULVO \text{ OFF}}$	ULVO Turn Off Delay	$I_F = 10 \text{ mA}$, $V_O < 5 \text{ V}$		0.3		μs
$ CM_H $	Common Mode Transient Immunity at Output High	$V_{DD} = 30 \text{ V}$, $I_F = 10 \text{ mA}$ to 16 mA , $V_{CM} = 2000 \text{ V}$, $T_A = 25^\circ\text{C}$ ⁽¹³⁾	50			$\text{kV}/\mu\text{s}$
$ CM_L $	Common Mode Transient Immunity at Output Low	$V_{DD} = 30 \text{ V}$, $V_F = 0 \text{ V}$, $V_{CM} = 2000 \text{ V}$, $T_A = 25^\circ\text{C}$ ⁽¹⁴⁾	50			$\text{kV}/\mu\text{s}$

Notes:

- Propagation delay t_{PHL} is measured from the 50% level on the falling edge of the input pulse to the 50% level of the falling edge of the V_O signal.
- Propagation delay t_{PLH} is measured from the 50% level on the rising edge of the input pulse to the 50% level of the rising edge of the V_O signal.
- PWD is defined as $|t_{PHL} - t_{PLH}|$ for any given device.
- The difference between t_{PHL} and t_{PLH} between any two FOD8343 parts under the same operating conditions, with equal loads.
- Common mode transient immunity at output high is the maximum tolerable negative dV_{cm}/dt on the trailing edge of the common mode impulse signal, V_{CM} , to ensure that the output remains high (i.e., $V_O > 15.0 \text{ V}$).
- Common mode transient immunity at output low is the maximum tolerable positive dV_{cm}/dt on the leading edge of the common pulse signal, V_{CM} , to ensure that the output remains low (i.e., $V_O < 1.0 \text{ V}$).

Typical Performance Characteristics

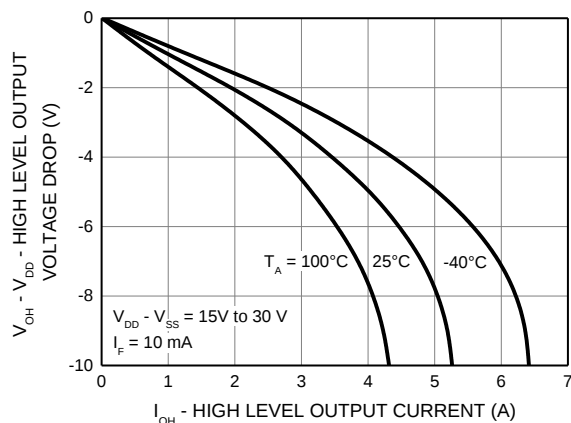


Figure 4. High Level Output Voltage Drop vs. High Level Output Current

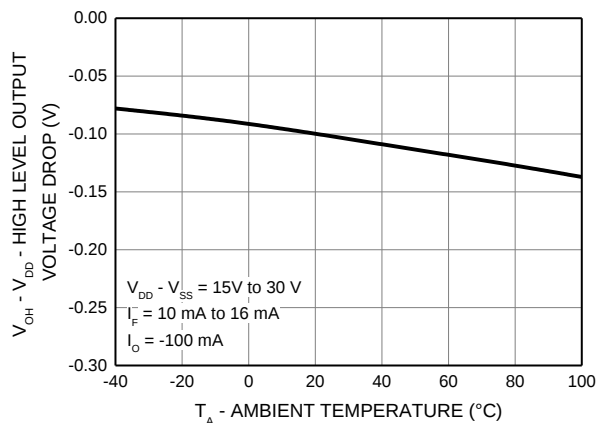


Figure 5. High Level Output Voltage Drop vs. Ambient Temperature

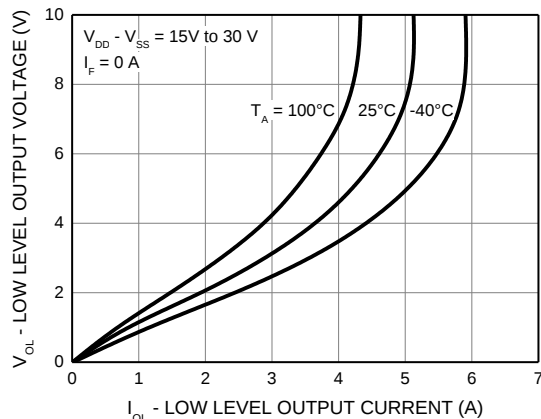


Figure 6. Low Level Output Voltage vs. Low Level Output Current

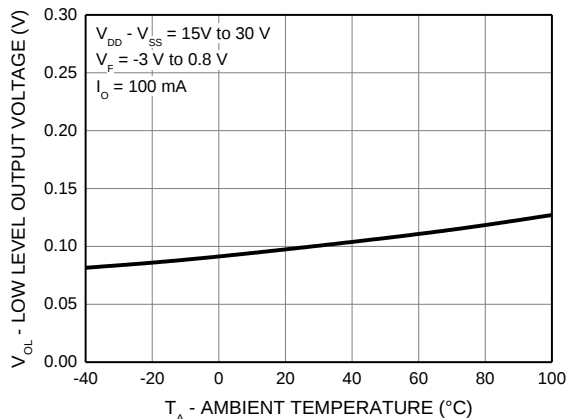


Figure 7. Low Level Output Voltage vs. Ambient Temperature

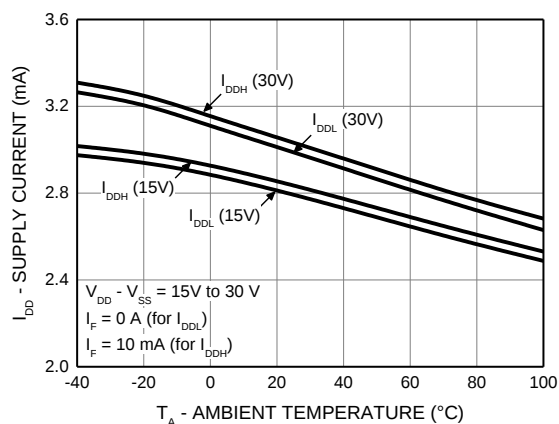


Figure 8. Supply Current vs. Ambient Temperature

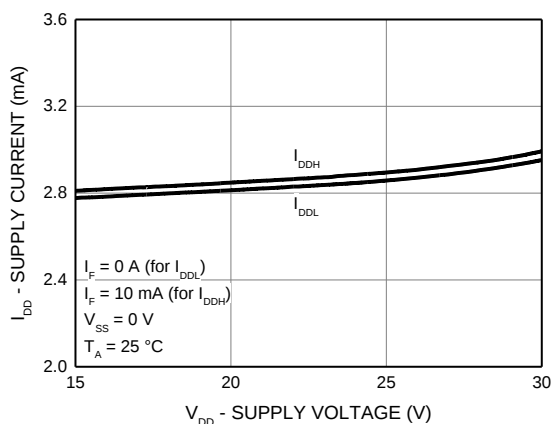


Figure 9. Supply Current vs. Supply Voltage

Typical Performance Characteristics (Continued)

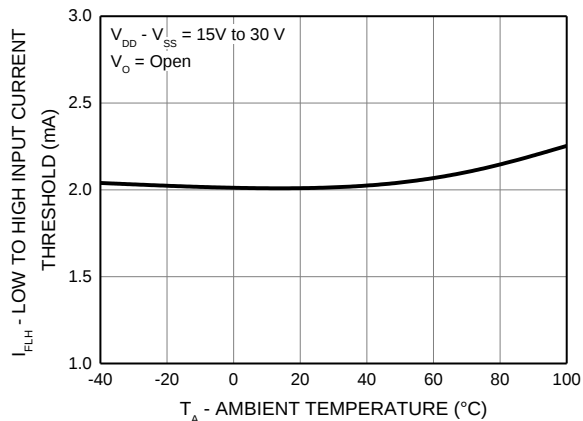


Figure 10. Low to High Input Current Threshold vs. Ambient Temperature

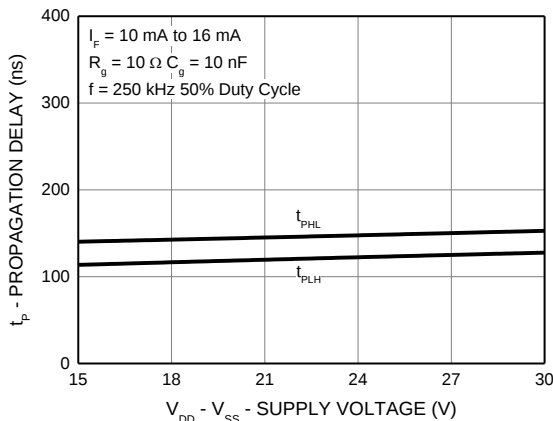


Figure 11. Propagation Delay vs. Supply Voltage

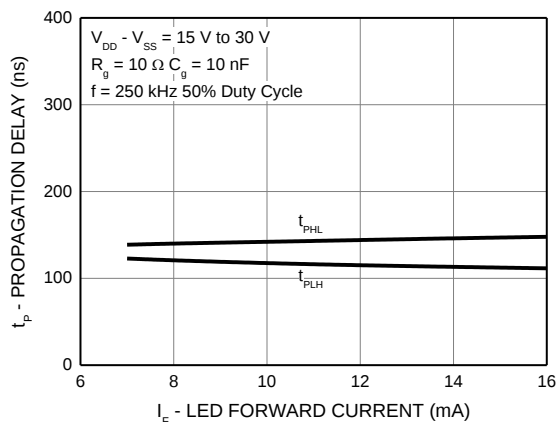


Figure 12. Propagation Delay vs. LED Forward Current

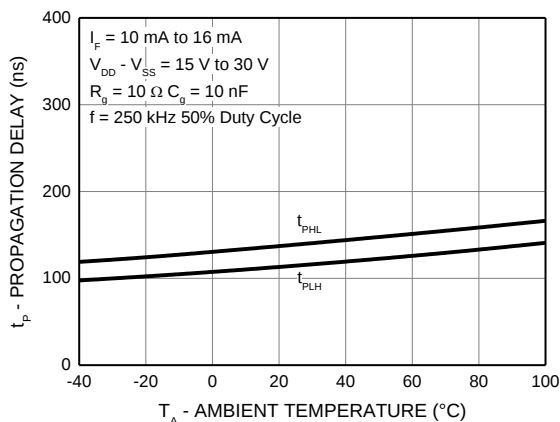


Figure 13. Propagation Delay vs. Ambient Temperature

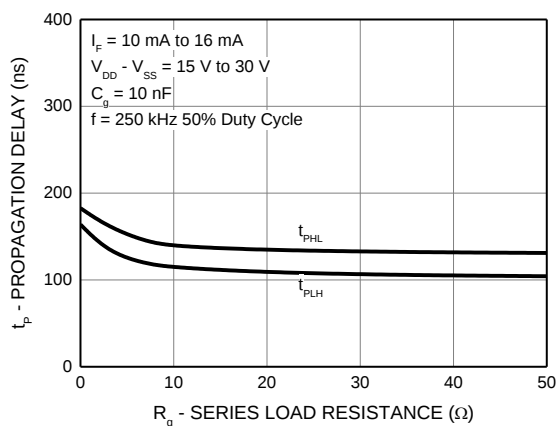


Figure 14. Propagation Delay vs. Series Load Resistance

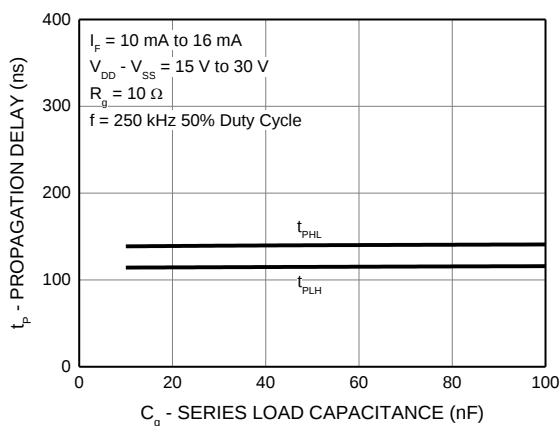


Figure 15. Propagation Delay vs. Series Load Capacitance

Typical Performance Characteristics (Continued)

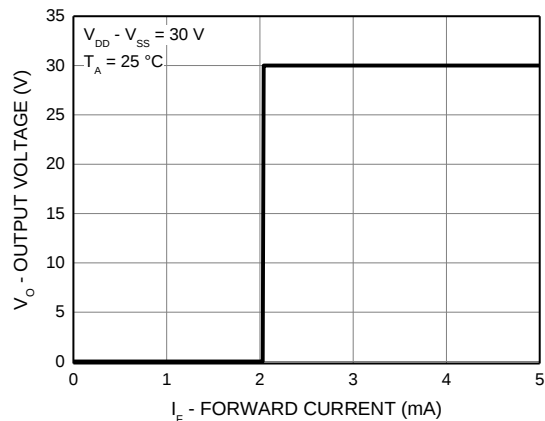


Figure 16. Transfer Characteristics

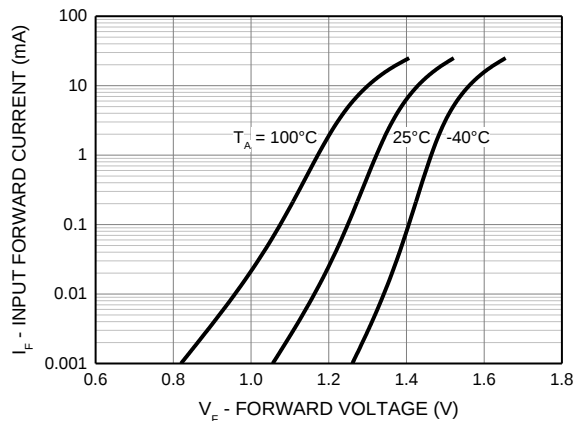


Figure 17. Input Forward Current vs. Forward Voltage

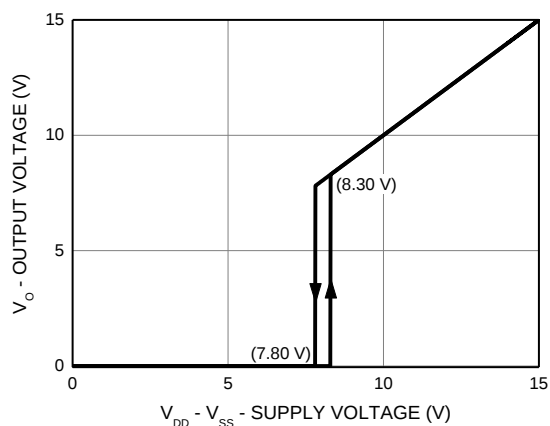


Figure 18. Under Voltage Lockout

Test Circuits

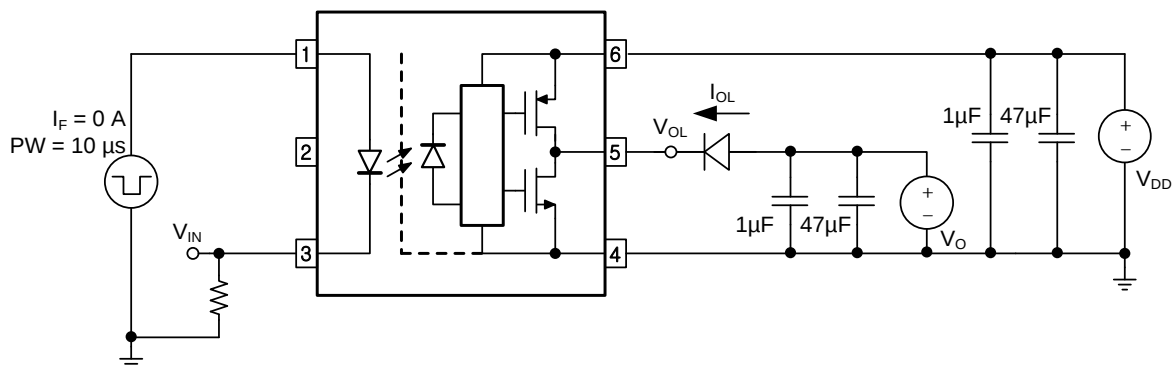


Figure 19. I_{OL} Test Circuit

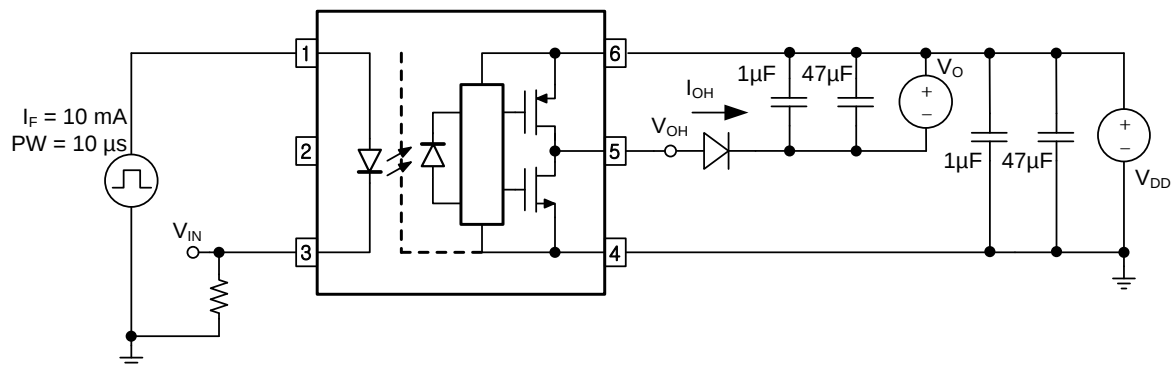


Figure 20. I_{OH} Test Circuit

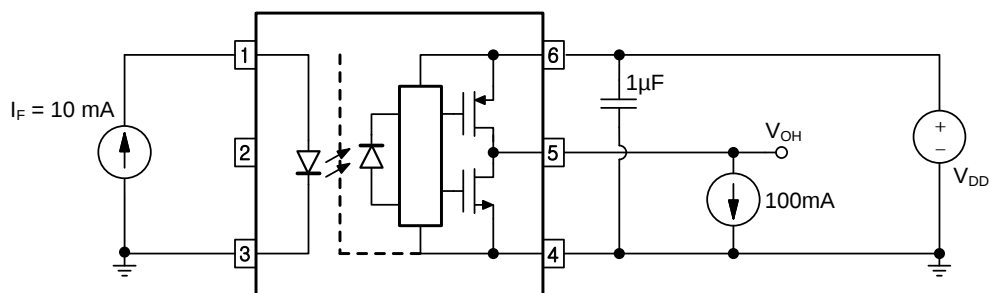


Figure 21. V_{OH} Test Circuit

Test Circuits (Continued)

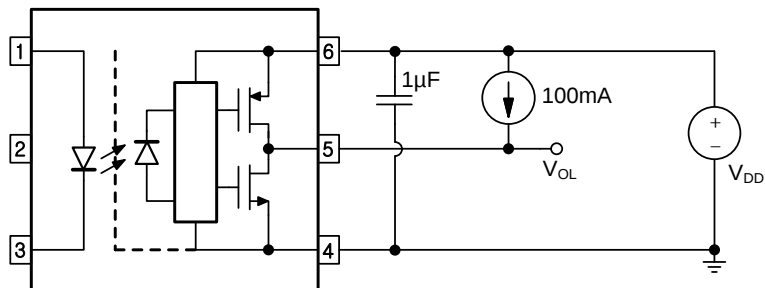


Figure 22. V_{OL} Test Circuit

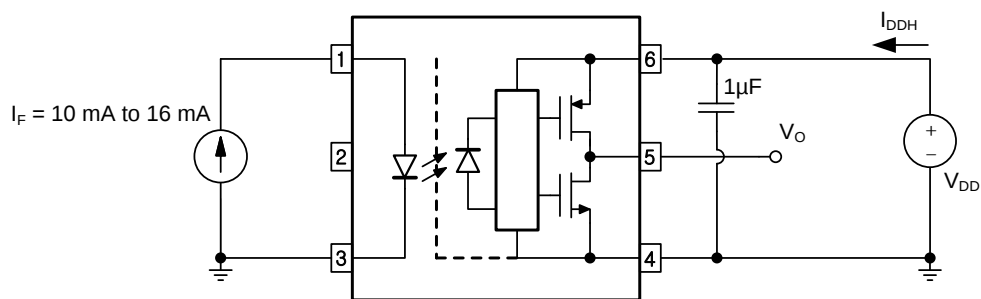


Figure 23. I_{DDH} Test Circuit

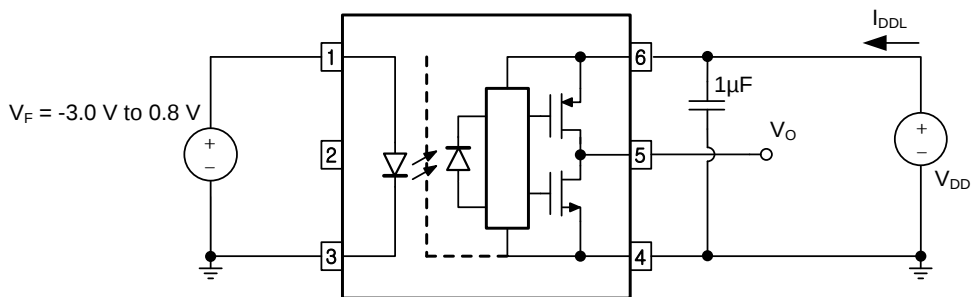


Figure 24. I_{DDL} Test Circuit

Test Circuits (Continued)

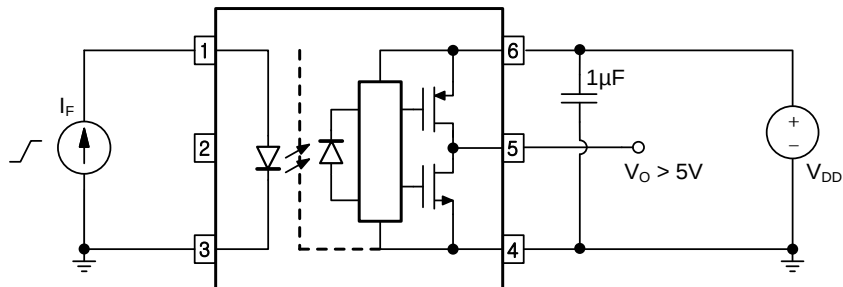


Figure 25. I_{FLH} Test Circuit

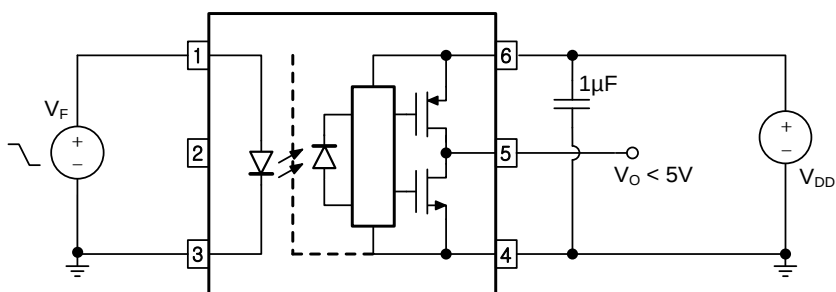


Figure 26. V_{FHL} Test Circuit

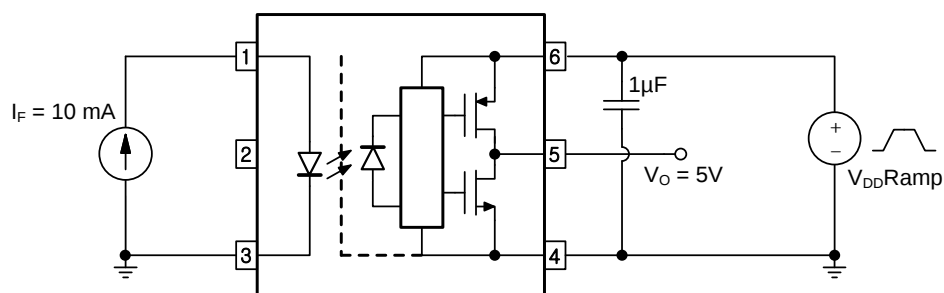


Figure 27. UVLO Test Circuit

Test Circuits (Continued)

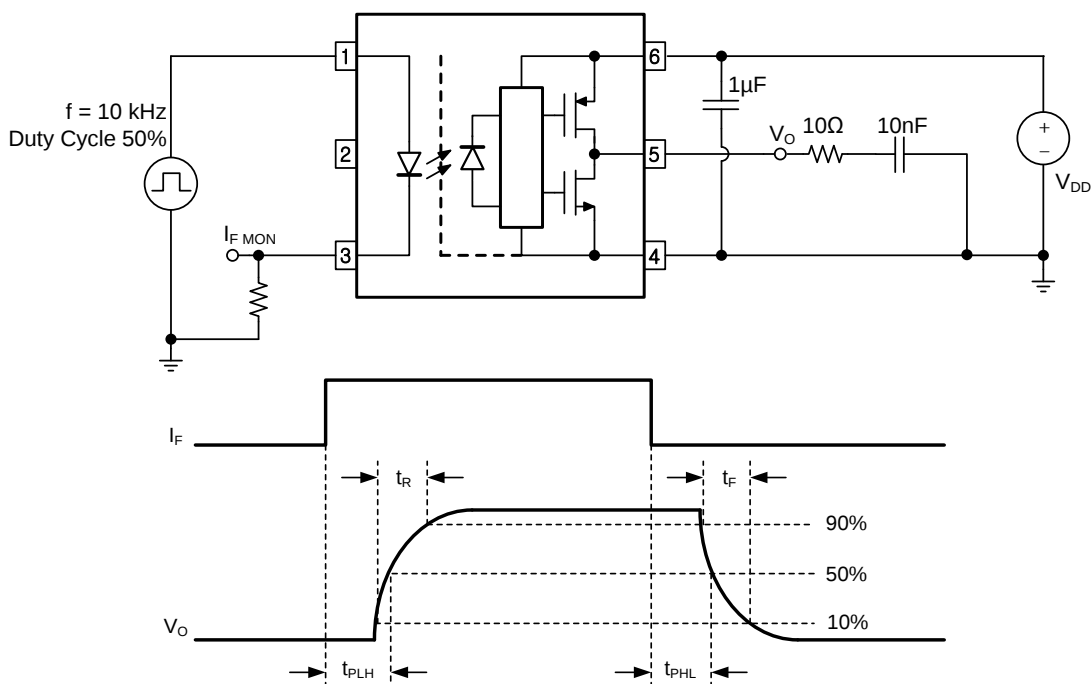
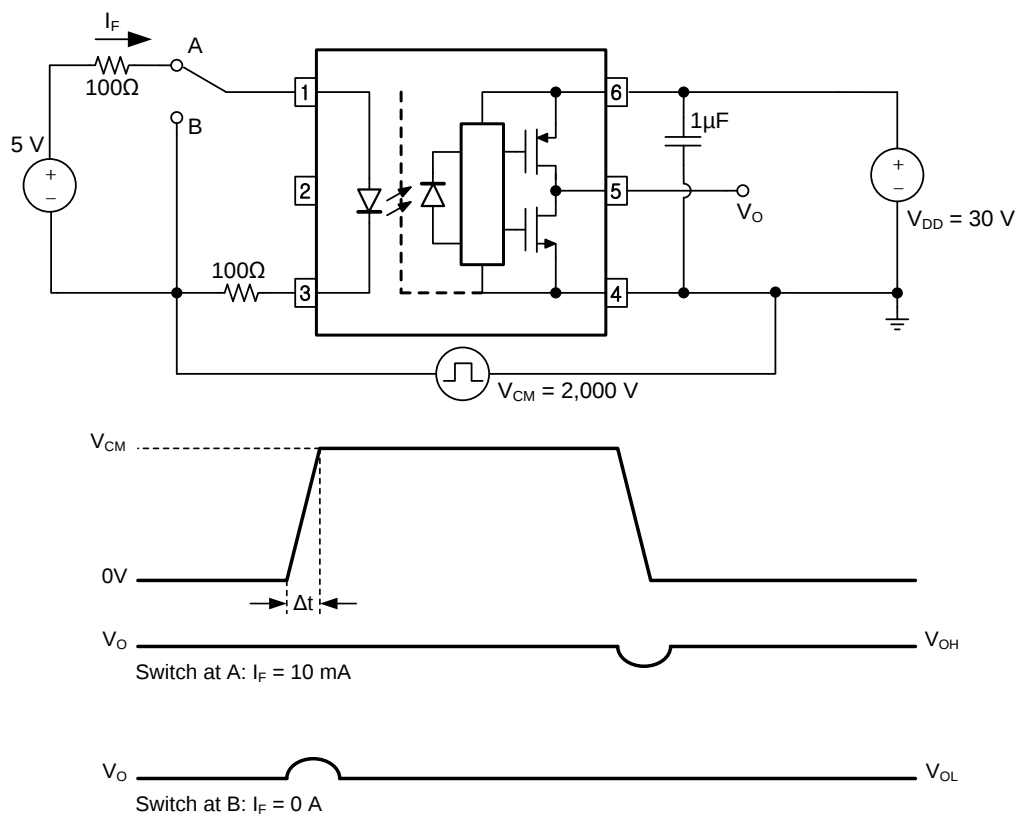
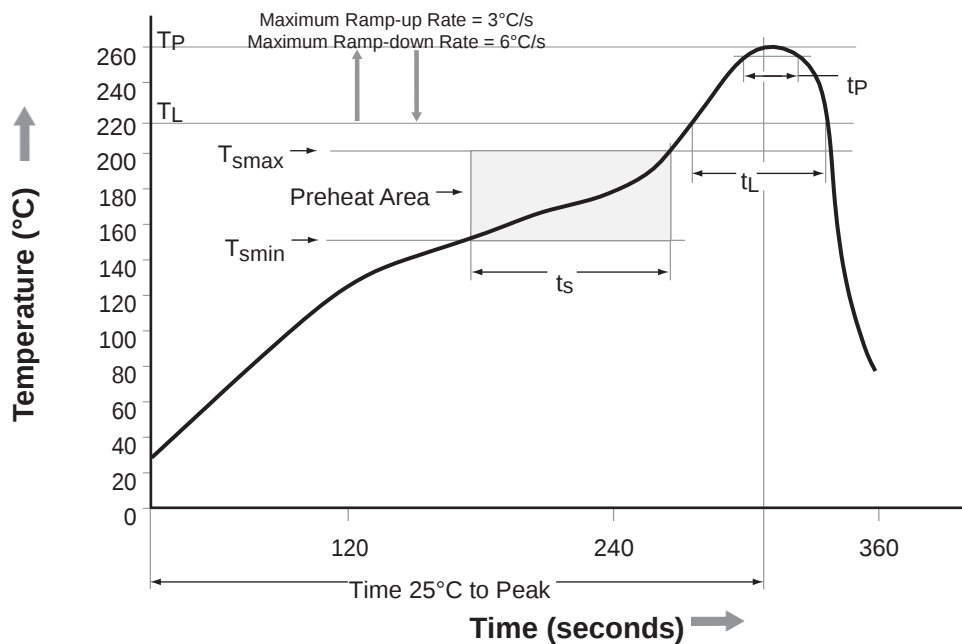
Figure 28. t_{PLH} , t_{PHL} , t_R and t_F Test Circuit and Waveforms

Figure 29. CMR Test Circuit and Waveforms

Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Minimum ($T_{\min}$)	150°C
Temperature Maximum ($T_{\max}$)	200°C
Time (t_s) from ($T_{\min}$ to $T_{\max}$)	60 s to 120 s
Ramp-up Rate (t_L to t_p)	3°C/second maximum
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60 s to 150 s
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t_p) within 5°C of 260°C	30 s
Ramp-Down Rate (T_P to T_L)	6°C/s maximum
Time 25°C to Peak Temperature	8 minutes maximum

Figure 34. Reflow Profile

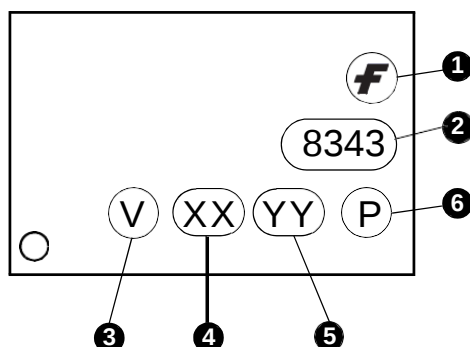
Ordering Information

Part Number	Package	Packing Method
FOD8343	Stretched Body SOP 6-Pin	Tube (100 units per tube)
FOD8343R2	Stretched Body SOP 6-Pin	Tape and Reel (1,000 units per reel)
FOD8343V	Stretched Body SOP 6-Pin, DIN EN/IEC60747-5-5 Option	Tube (100 units per tube)
FOD8343R2V	Stretched Body SOP 6-Pin, DIN EN/IEC60747-5-5 Option	Tape and Reel (1,000 units per reel)
FOD8343T	Stretched Body SOP 6-Pin, Wide Lead	Tube (100 units per tube)
FOD8343TR2	Stretched Body SOP 6-Pin, Wide Lead	Tape and Reel (1,000 units per reel)
FOD8343TV	Stretched Body SOP 6-Pin, Wide Lead, DIN EN/IEC60747-5-5 Option	Tube (100 units per tube)
FOD8343TR2V	Stretched Body SOP 6-Pin, Wide Lead, DIN EN/IEC60747-5-5 Option	Tape and Reel (1,000 units per reel)

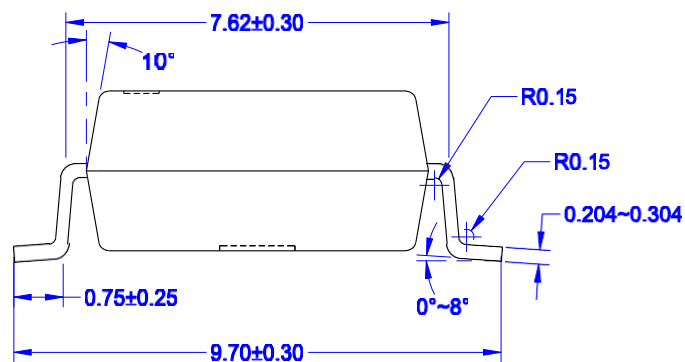
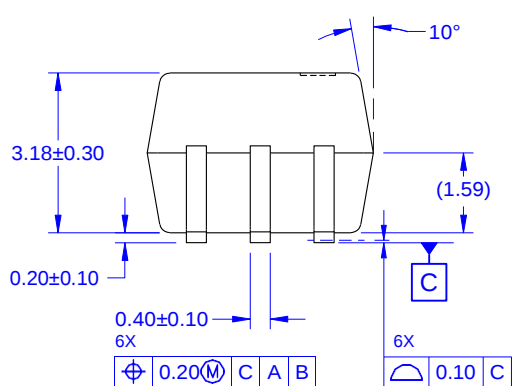
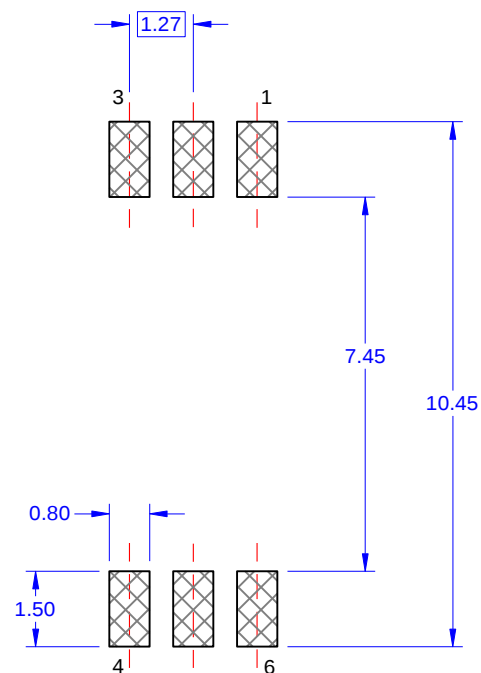


All packages are lead free per JEDEC: J-STD-020B standard.

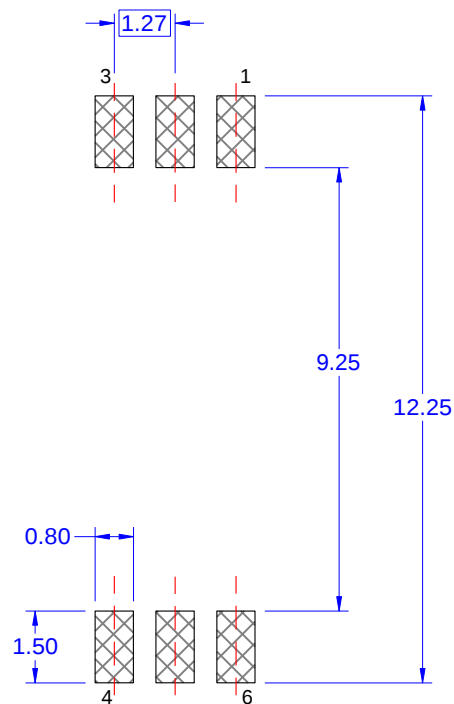
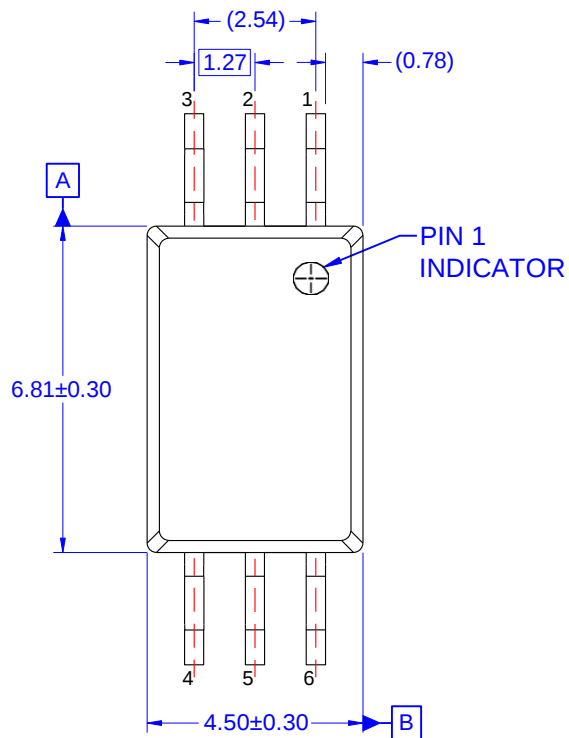
Marking Information



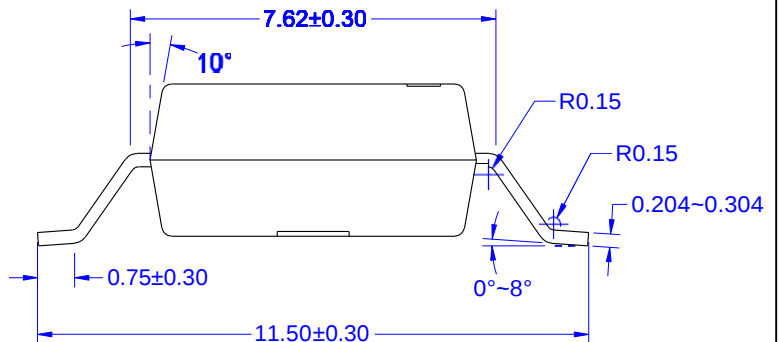
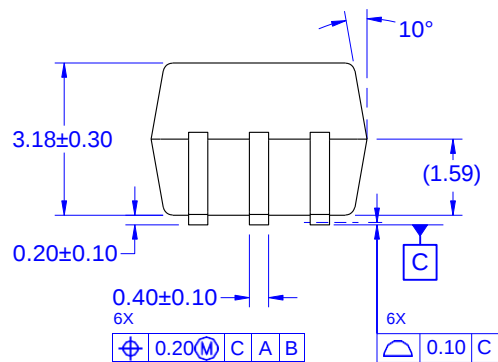
Definitions	
1	Logo
2	Device Number, e.g. 8343
3	DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option) (Pending Approvals)
4	Two Digit Year Code, e.g. '15'
5	Two Digit Work Week Ranging from '01' to '53'
6	Assembly Package Code



- A) NO STANDARD APPLIES TO THIS PACKAGE
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH, AND TIE BAR EXTRUSION.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- E) DRAWING FILE NAME: MKT-M06BREV1



RECOMMENDED LAND PATTERN



NOTES: UNLESS OTHERWISE SPECIFIED

- A) NO STANDARD APPLIES TO THIS PACKAGE
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH, AND TIE BAR EXTRUSION.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- E) DRAWING FILE NAME: MKT-M06CREV1

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